



# DB2J20900L

Silicon epitaxial planar type

For high frequency rectification  
 DB3X209K in SMini2 type package

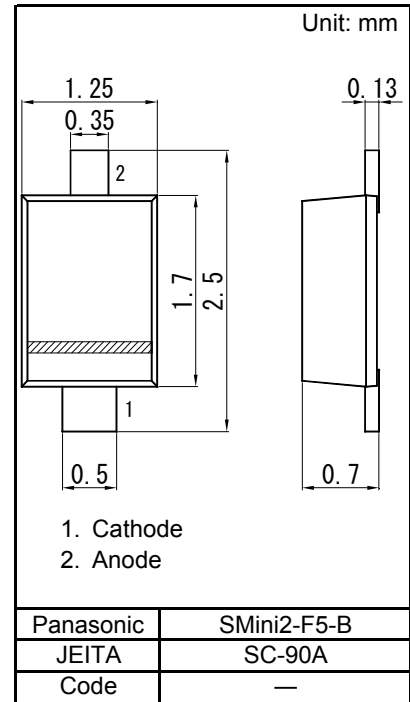
■ Features

- Low forward voltage VF
- Short reverse recovery time trr
- Halogen-free / RoHS compliant  
 (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol: BE

■ Packaging

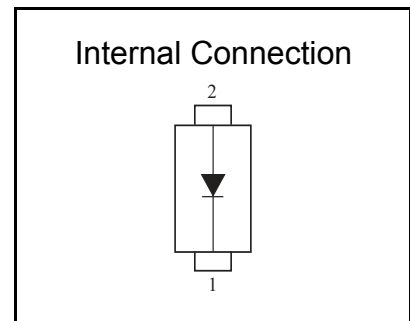
Embossed type (Thermo-compression sealing) : 3 000 pcs / reel (standard)



■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Reverse voltage	VR	20	V
Repetitive peak reverse voltage	VRRM	20	V
Forward current (Average)	IF(AV)	500	mA
Non-repetitive peak forward surge current *1	IFSM	3	A
Junction temperature	Tj	125	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +125	°C

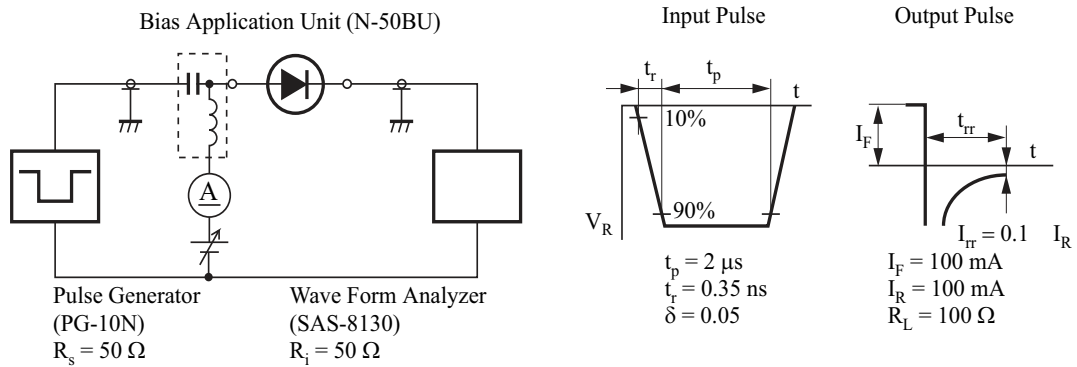
Note: \*1 50Hz sine wave 1 cycle ( Non-repetitive peak current )



■ Electrical Characteristics  $T_a = 25\text{ }^\circ\text{C} \pm 3\text{ }^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	VF1	$I_F = 10\text{ mA}$			0.3	V
	VF2	$I_F = 500\text{ mA}$			0.5	
Reverse current	IR	$V_R = 10\text{ V}$			30	$\mu\text{A}$
Terminal capacitance	Ct	$V_R = 10\text{ V}, f = 1\text{ MHz}$		7		pF
Reverse recovery time *1	trr	$I_F = I_R = 100\text{ mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100\ \Omega$		2.4		ns

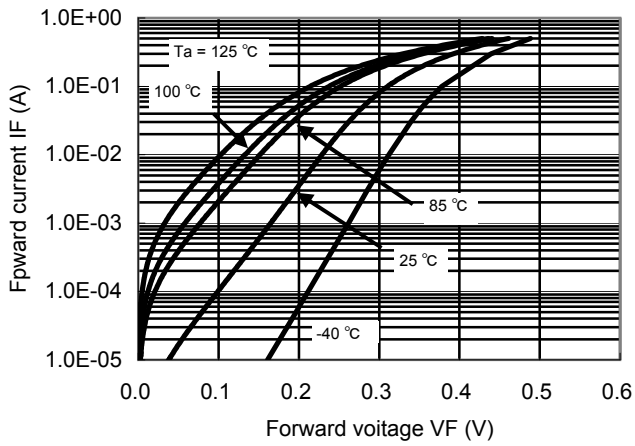
- Note: 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.  
 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.  
 3. Absolute frequency of Input and output is 400 MHz.  
 4. \*1 : trr measurement circuit



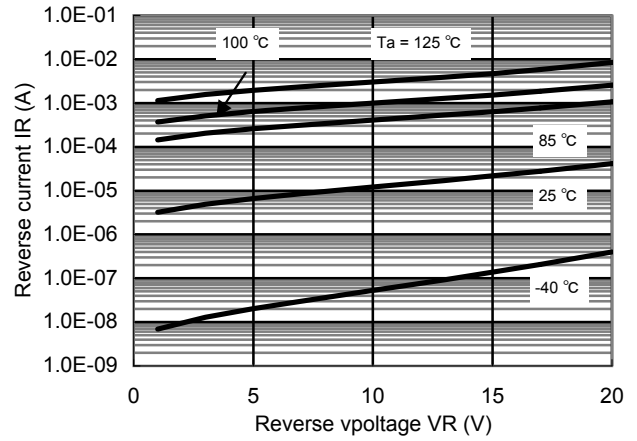


Technical Data ( reference )

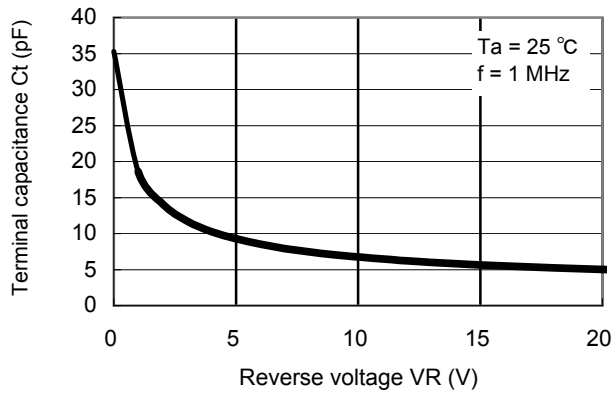
IF - VF



IR - VR



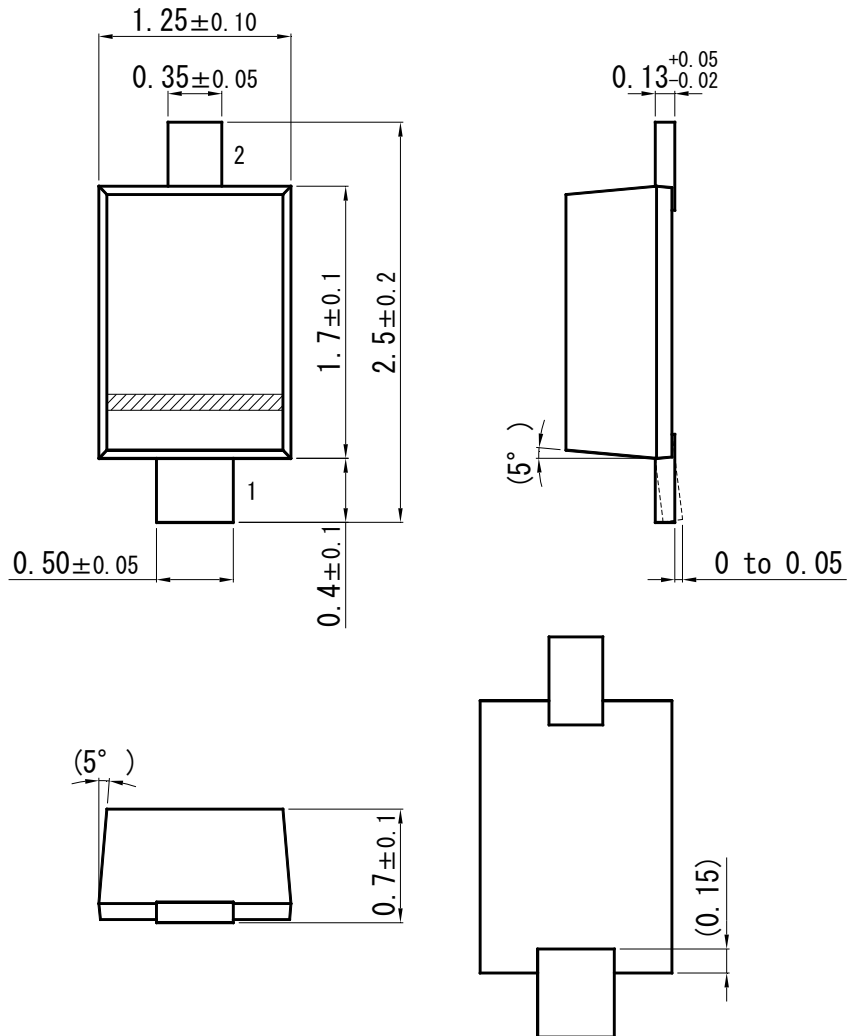
Ct - VR



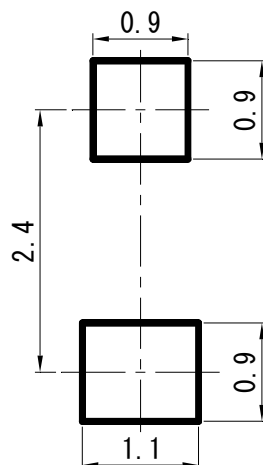
**Panasonic**

SMini2-F5-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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